

HAT2164H

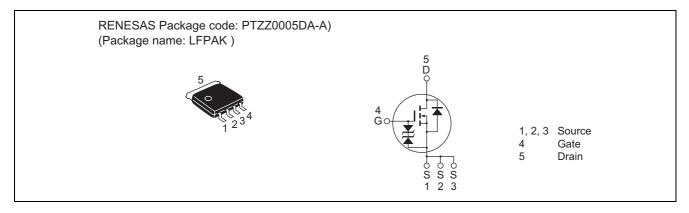
Silicon N Channel Power MOS FET Power Switching

> REJ03G0003-0500 Rev.5.00 Sep 26, 2005

Features

- Capable of 4.5 V gate drive
- Low drive current
- High density mounting
- Low on-resistance
- $R_{DS(on)} = 2.5 \text{ m}\Omega \text{ typ.} (at V_{GS} = 10 \text{ V})$

Outline



Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	60	A
Drain peak current	Note1 I _{D(pulse)}	240	A
Body-drain diode reverse drain current	I _{DR}	60	A
Avalanche current	I _{AP} Note 2	30	A
Avalanche energy	E _{AR} Note 2	90	mJ
Channel dissipation	Pch Note3	30	W
Channel to Case Thermal Resistance	θch-C	4.17	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	٥C

Notes: 1. PW \leq 10 $\mu s,$ duty cycle \leq 1%

2. Value at Tch = 25°C, Rg \ge 50 Ω

3. Tc = 25°C



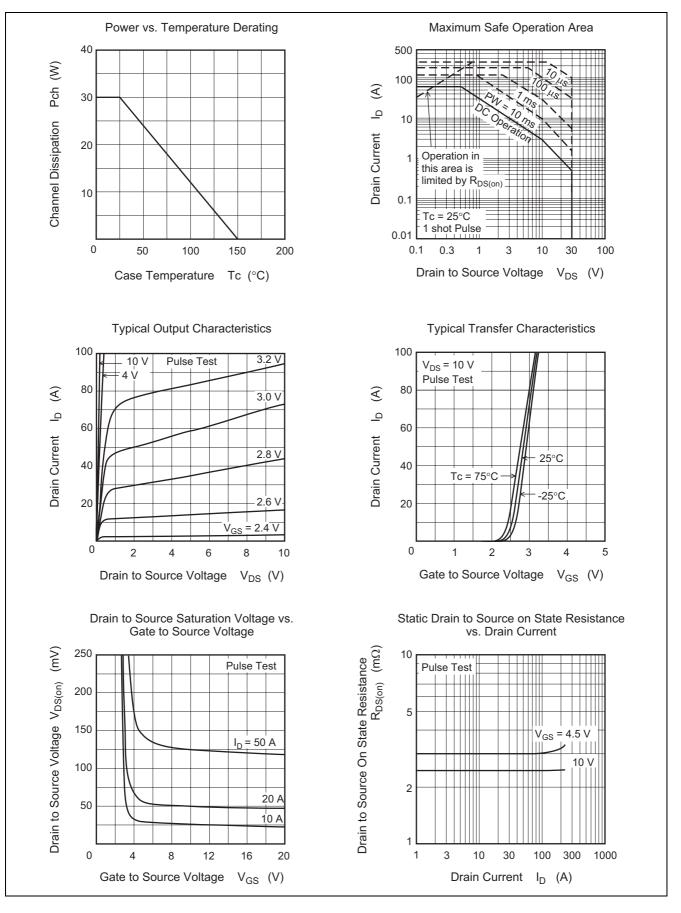
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	30	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_		±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_		1	μΑ	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	0.8		2.3	V	V _{DS} = 10 V, I _D = 1 mA
Static drain to source on state	R _{DS(on)}	_	2.5	3.1	mΩ	$I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}		3.0	4.4	mΩ	$I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	78	130	_	S	$I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss		7600	_	pF	V _{DS} = 10 V, V _{GS} = 0, f = 1 MHz
Output capacitance	Coss		1050	_	pF	
Reverse transfer capacitance	Crss	_	470		pF	
Gate Resistance	Rg		0.5	_	Ω	
Total gate charge	Qg		50	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$
Gate to source charge	Qgs		22		nC	I _D = 60 A
Gate to drain charge	Qgd		10	_	nC	
Turn-on delay time	t _{d(on)}		18		ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A},$
Rise time	tr		60	_	ns	$V_{\text{DD}} \cong 10 \text{ V}, \text{ R}_{\text{L}} = 0.33 \Omega,$ Rg = 4.7 Ω
Turn-off delay time	t _{d(off)}		65	_	ns	
Fall time	t _f	_	15	_	ns	
Body-drain diode forward voltage	V _{DF}	_	0.82	1.07	V	$IF = 60 A, V_{GS} = 0^{Note4}$
Body-drain diode reverse recovery	t _{rr}		40	_	ns	IF = 60 A, V _{GS} = 0
time						di _F / dt = 100 A/ μs

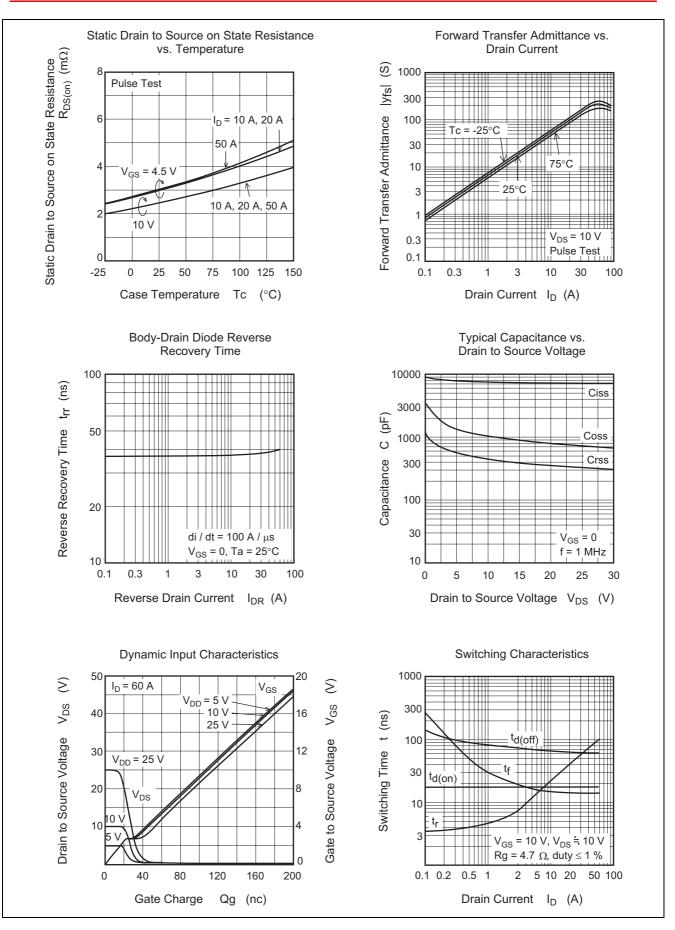
Notes: 4. Pulse test



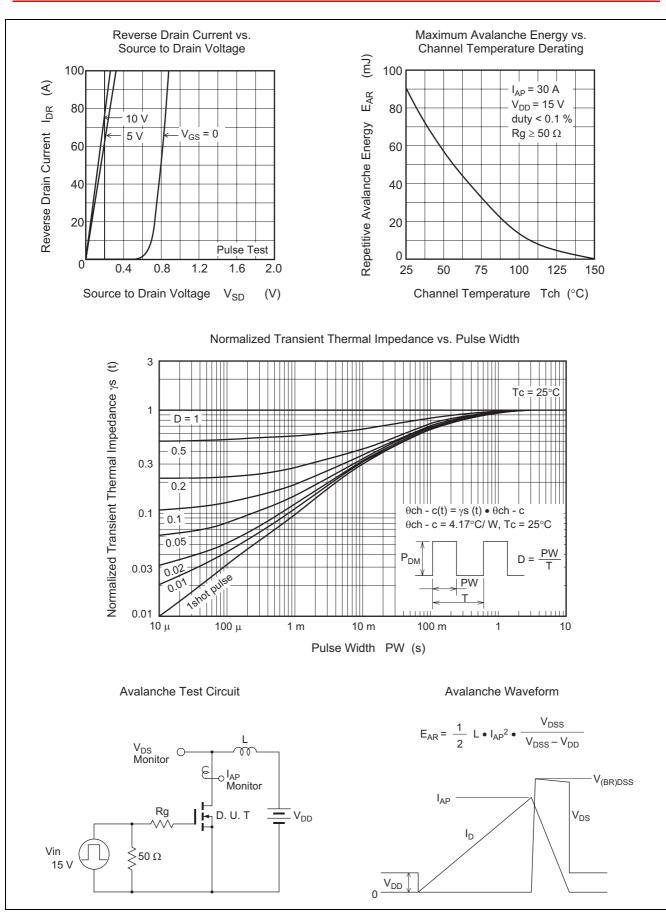
Main Characteristics



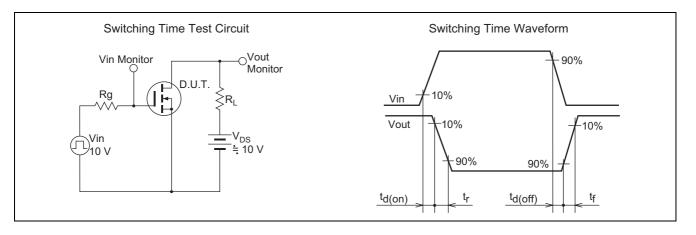






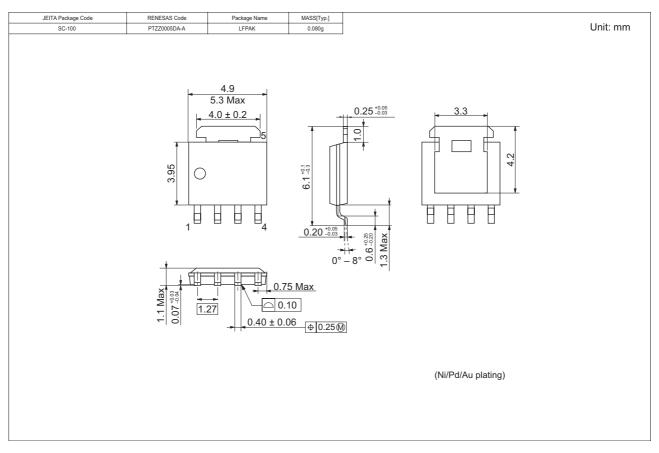








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2164H-EL-E	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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